

NCE55P15

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE55P15 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

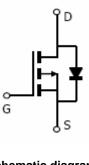
- V_{DS} =-55V, I_{D} =-15A $R_{DS(ON)}$ <75m Ω @ V_{GS} =-10V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- DC-DC converter

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram



Marking and pin assignment



TO-220-3L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE55P15	NCE55P15	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃ unless otherwise noted)

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Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	-55	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	-15	А
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	-10	Α
Pulsed Drain Current	I _{DM}	-50	А
Maximum Power Dissipation	P _D	45	W
Operating Junction and Storage Temperature Range	T_J, T_STG	-55 To 175	°C



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Thermal Characteristic

Electrical Characteristics (Tc=25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS} V_{GS} =0V I_D =-250 μ A		-55	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-55V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	<u> </u>					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-1.5	-2.6	-3.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-5A	-	60	75	mΩ
Forward Transconductance	ward Transconductance g_{FS} V_{DS} =-15V, I_D =-5A		16	-	-	S
Dynamic Characteristics (Note4)	<u> </u>					
Input Capacitance	C _{lss}		-	1450	-	PF
Output Capacitance	Coss	V_{DS} =-20V, V_{GS} =0V,	-	145	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	110	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	8	-	nS
Turn-on Rise Time	t _r	V_{DD} =-30 V , , R_L =30 Ω	-	9	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10 V , R_{GEN} =6 Ω	-	65	-	nS
Turn-Off Fall Time	t _f		-	30	-	nS
Total Gate Charge	Qg	V - 20VI - FA	-	26	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-30V, I_{D} =-5A, V_{GS} =-10V	-	4.5	-	nC
Gate-Drain Charge	Q_{gd}	v _{GS} =-10v	-	7	-	nC
Drain-Source Diode Characteristics	<u> </u>		•			
Diode Forward Voltage (Note 3)	V _{SD}	V_{GS} =0 V , I_{S} =-5 A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	-15	Α

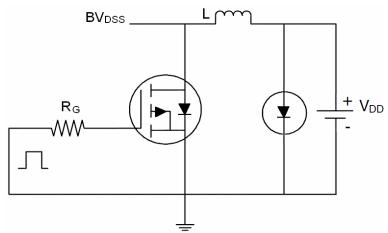
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

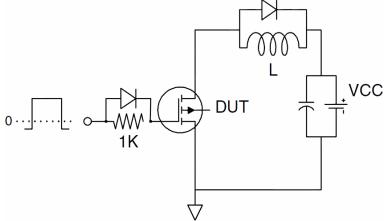


Test Circuit

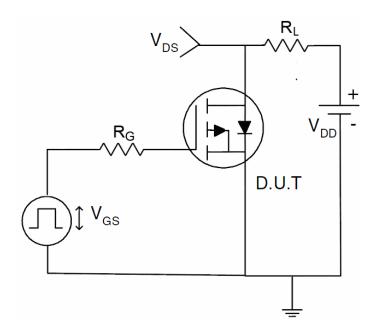
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

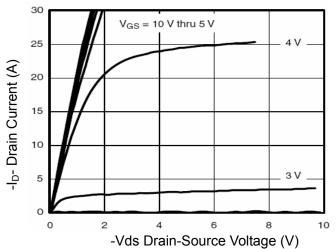


Figure 1 Output Characteristics

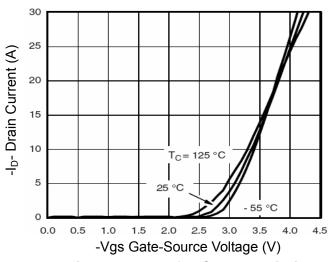


Figure 2 Transfer Characteristics

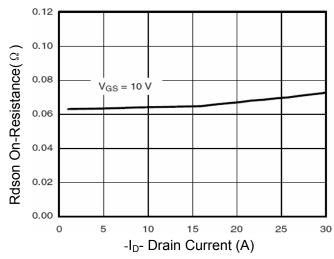


Figure 3 Rdson- Drain Current

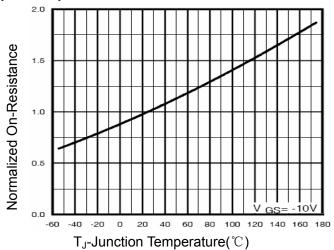


Figure 4 Rdson-Junction Temperature

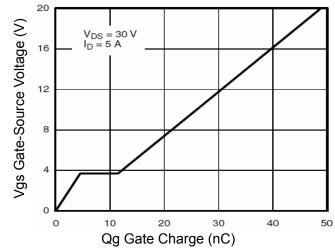


Figure 5 Gate Charge

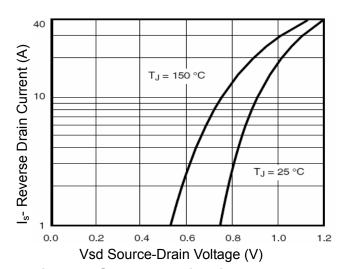


Figure 6 Source- Drain Diode Forward



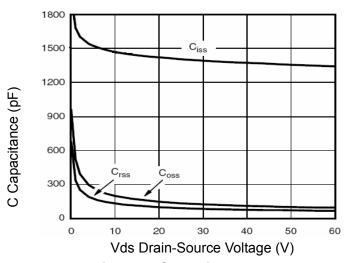


Figure 7 Capacitance vs Vds

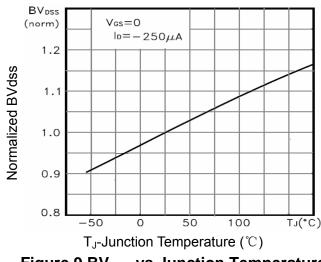


Figure 9 BV_{DSS} vs Junction Temperature

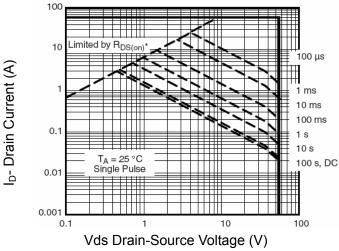


Figure 8 Safe Operation Area

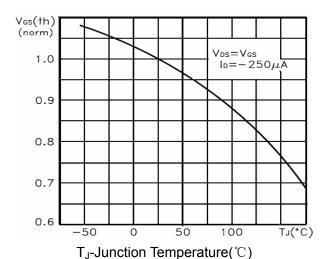


Figure 10 V_{GS(th)} vs Junction Temperature

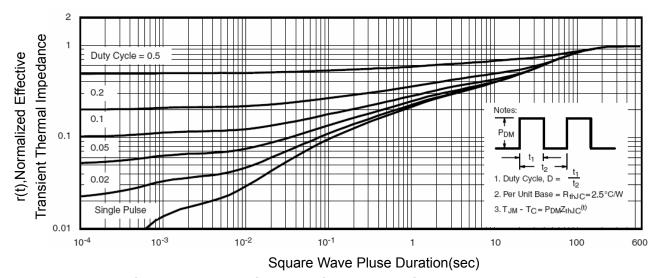
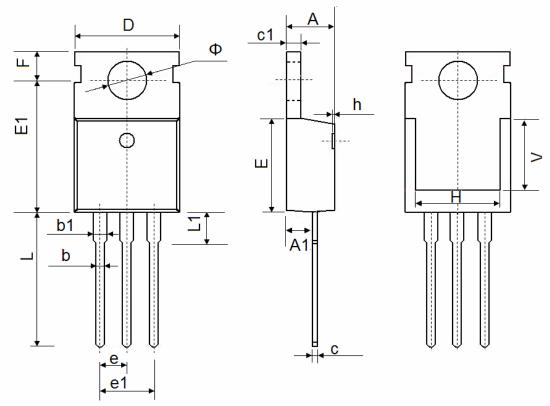


Figure 11 Normalized Maximum Transient Thermal Impedance

Pb Free Product



TO-220-3L Package Information



Cumbal	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
Е	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540	TYP.	0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500	REF.	0.295 REF.		
Ф	3.400	3.800	0.134	0.150	



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